503383194 07/08/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3429816

SUBMISSION TYPE:		NEW ASSIGNMENT				
NATURE OF CONVEYANCE:		ASSIGNMENT				
CONVEYING PARTY D	ΑΤΑ					
			Name		Execution Date	
CHANHO PARK					07/06/2015	
AYMAN SHIBIB					07/08/2015	
KYLE TERRILL					07/07/2015	
RECEIVING PARTY DA	ATA					
Name: VISHAY-SILICONIX						
Street Address:	2201 L	AURE				
City:	SANTA	SANTA CLARA				
State/Country:	CALIF	CALIFORNIA				
Postal Code:	95054	95054				
Property Type Application Number: 1479		1479	Number 4164			
Application Number: 1479		1479	4164			
CORRESPONDENCE I	ΔΤΑ					
		938-9069				
		o the	e-mail address first; if that is uns			
<i>using a fax number, if</i> Phone:	provideo		nat is unsuccessful, it will be sen 038-9060	t via US N	Nail.	
		action@mhbpatents.com				
			AY/SILICONIX C/O MURABITO, H	AO & BAF	3	
Address Line 1: TWO		NORTH MARKET STREET				
		D FLOOR				
Address Line 4:		SAN	JOSE, CALIFORNIA 95113			
ATTORNEY DOCKET NUMBER:			VISH-8824			
NAME OF SUBMITTER:			WILLIAM A. ZARBIS			
SIGNATURE:			/William A. Zarbis/			
DATE SIGNED:		07/08/2015				
Total Attachments: 1						
source=VISH-8824_ASS	IGNMEN	T_sig	ned_ALL_INVENTORS#page1.tif			

Assignment to VISHAY-SILICONIX

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we

Chanho PARK, Ayman SHIBIB, Kyle TERRILL

do hereby sell, assign, and transfer unto Vishay-Siliconix (hereinafter called Vishay-Siliconix), a Delaware Corporation having its principal place of business at 2201 Laurelwood Road, Santa Clara, CA 95054, and its successors and assigns, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

SEMICONDUCTOR DEVICE WITH NON-UNIFORM TRENCH OXIDE LAYER

X filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; or

Serial No .: filed on and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor;

And for the above consideration, I/we agree promptly upon request of Vishay-Siliconix, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to Vishay-Siliconix, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by Vishay-Siliconix.

I/we further covenant with Vishay-Siliconix, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we hereunto set my/our hand(s) and seal:

Inventor's Signature:

6,2015 Date:

Chanho PÅRK

Inventor's Signature:

Date: July

Date:

Inventor's Signature:

Page 1 of 1

∕le TERRI

rev. 11/97 epn PATENT

RECORDED: 07/08/2015

REEL: 036025 FRAME: 0085